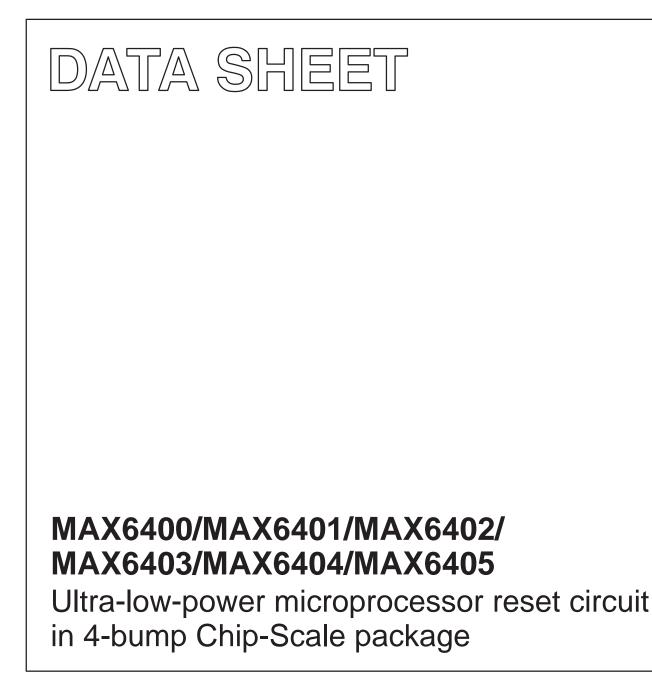
# INTEGRATED CIRCUITS



Product data

2003 May 27



## MAX6400/MAX6401/MAX6402/ MAX6403/MAX6404/MAX6405

### DESCRIPTION

The MAX6400/MAX6401//MAX6402/MAX6403/MAX6404/MAX6405 microprocessor ( $\mu$ P) reset circuits monitor power supplies in  $\mu$ P and digital systems. These devices eliminate external components and adjustments while providing excellent circuit reliability and low cost solution. They are used to monitor 2.5 V, 3 V, 3.3 V and 5 V power supplies. A manual reset input is also available.

MAX6400-MAX6405 assert a reset signal when the V<sub>DD</sub> supply voltage falls below a preset reset threshold voltage. The reset signal remains asserted for at least 100 ms after the V<sub>DD</sub> rises above the reset threshold. The reset threshold are factory trimmable from 2.2 V to 4.63 V in approximately 100 mV increments. All these parts are guaranteed to assert a reset for V<sub>DD</sub> down to 1 V. They have excellent immunity to fast transients on V<sub>DD</sub>.

The devices vary in their output configuration. The MAX6400/MAX6403 have push-pull, active-LOW reset output; while the MAX6402/MAX6405 have open drain, active-LOW reset output. The MAX6401/MAX6404 have push-pull, active-HIGH reset output.

The lower threshold MAX6400/MAX6401/MAX6402 have ultra-low supply current of typically 500 nA, making them ideal for battery powered applications. All six devices are available in the 4-bump Chip-Scale (WL-CSP4) package.

### FEATURES

- Ultra-Low 1 µA (max) supply current
- Precision monitoring of 2.5 V, 3 V, 3.3 V, and 5 V power supply voltages
- Reset thresholds available from 2.2 V to 4.63 V
- $\pm 2.5\%$  threshold accuracy from –40 °C to +85 °C
- 100 ms (min) Power-on-Reset delay time
- Manual Reset input
- Power transient immunity
- Available in three versions: push-pull RESET, push-pull RESET, and open-drain RESET
- Guaranteed reset valid to  $V_{DD} = 1.0 V$
- Ultra-small 4-bump Chip-Scale packages

### SIMPLIFIED SYSTEM DIAGRAM

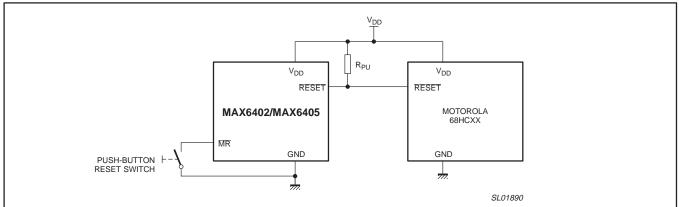


Figure 1. Simplified system diagram.



# APPLICATIONS

- PDAs and pagers
- MP3 players
- Portable/battery-powered equipment
- Cellular phones

# MAX6400/MAX6401/MAX6402/ MAX6403/MAX6404/MAX6405

### **ORDERING INFORMATION**

### MAX6400/MAX6401/MAX6402

TYPE NUMBER	PACKAGE	ACKAGE		
NAME		DESCRIPTION	RANGE	
MAX6400- <b>XX</b> UK	WL-CSP4	Wafer-level, chip-scale package; 4 bumps; surface mount	–40 °C to +85 °C	
MAX6401- <b>XX</b> UK	WL-CSP4	Wafer-level, chip-scale package; 4 bumps; surface mount	–40 °C to +85 °C	
MAX6402- <b>XX</b> UK	WL-CSP4	Wafer-level, chip-scale package; 4 bumps; surface mount	–40 °C to +85 °C	

#### NOTE:

Each device has 5 standard voltage options, indicated by **'XX'** on the 'Type number'. Additional voltage options may be available (see Table 1 for details).

XX (type number suffix)	Reset threshold voltage (V) (Typical)
22	2.200
23	2.320
26	2.630
29	2.930
31	3.080

### MAX6403/MAX6404/MAX6405

TYPE NUMBER	PACKAGE	TEMPERATURE RANGE	
NAME			
MAX6403- <b>XX</b> UK	WL-CSP4	Wafer-level, chip-scale package; 4 bumps; surface mount	–40 °C to +85 °C
MAX6404- <b>XX</b> UK	WL-CSP4	Wafer-level, chip-scale package; 4 bumps; surface mount	–40 °C to +85 °C
MAX6405- <b>XX</b> UK	WL-CSP4	Wafer-level, chip-scale package; 4 bumps; surface mount	–40 °C to +85 °C

#### NOTE:

Each device has 2 standard voltage options, indicated by **'XX'** on the 'Type number'. Additional voltage options may be available (see Table 1 for details).

XX (type number suffix)	Reset threshold voltage (V) (Typical)
44	4.380
46	4.630

# MAX6400/MAX6401/MAX6402/ MAX6403/MAX6404/MAX6405

		Reset Thre	eshold Voltage,	V <sub>th</sub> (V)			
Part number	Suffix (XX)	T <sub>amb</sub> = +25	T <sub>amb</sub> = +25 °C			$T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$	
		Min	Тур	Max	Min	Max	
	22	2.167	2.200	2.233	2.145	2.250	
	23	2.285	2.320	2.355	2.262	2.375	
	24 (Note 2)	2.364	2.400	2.436	2.340	2.460	
	25 (Note 2)	2.462	2.500	2.537	2.437	2.562	
MAX6400-XXUK	26	2.591	2.630	2.669	2.564	2.696	
MAX6401- <b>XX</b> UK MAX6402- <b>XX</b> UK	27 (Note 2)	2.660	2.700	2.741	2.633	2.768	
WAX0402-XXUK	28 (Note 2)	2.758	2.800	2.842	2.730	2.870	
	29	2.886	2.930	2.974	2.857	3.000	
	30 (Note 2)	2.955	3.000	3.045	2.925	3.075	
	31	3.034	3.080	3.126	3.003	3.150	
	33 (Note 2)	3.250	3.300	3.350	3.217	3.383	
	34 (Note 2)	3.349	3.400	3.451	3.315	3.485	
	35 (Note 2)	3.447	3.500	3.552	3.412	3.587	
	36 (Note 2)	3.546	3.600	3.654	3.510	3.690	
	37 (Note 2)	3.644	3.700	3.755	3.607	3.792	
	38 (Note 2)	3.743	3.800	3.857	3.705	3.895	
MAX6403-XXUK	39 (Note 2)	3.841	3.900	3.958	3.802	3.997	
MAX6404-XXUK	40 (Note 2)	3.940	4.000	4.060	3.900	4.100	
MAX6405- <b>XX</b> UK	41 (Note 2)	4.038	4.100	4.161	3.997	4.202	
	42 (Note 2)	4.137	4.200	4.263	4.095	4.305	
	43 (Note 2)	4.235	4.300	4.364	4.192	4.407	
	44	4.314	4.380	4.446	4.270	4.489	
	45 (Note 2)	4.432	4.500	4.567	4.387	4.612	
	46	4.560	4.630	4.699	4.3514	4.746	

### Table 1. Factory-trimmed reset thresholds (note 1)

NOTES:

1. Factory-trimmed reset thresholds are available in 100 mV increments with  $\pm 1.5\%$  tolerance at room temperature.

2. Consult factory for availability.

# MAX6400/MAX6401/MAX6402/ MAX6403/MAX6404/MAX6405

### PINNING

### MAX6400/MAX6402/MAX6403/MAX6405

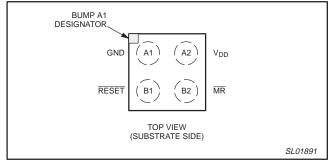


Figure 2. MAX6400/MAX6402/MAX6403/MAX6405 pin configuration.

### MAX6400/MAX6402/MAX6403/MAX6405 Pin description

BUMP	SYMBOL	DESCRIPTION		
A1	GND	Device ground.		
A2	V <sub>DD</sub>	Positive supply voltage.		
B1	RESET	Active-LOW Reset output. RESET remains LOW while $V_{DD}$ is below the reset threshold and for a reset delay time of at least 100 ms after $V_{DD}$ rises above the reset threshold. MAX6402/MAX6405 have open-drain output and the MAX6400/MAX6403 are push-pull output.		
B2	MR	Active-LOW Manual Reset. Internal 50 k $\Omega$ pull-up resistor to V <sub>DD</sub> . Pull LOW to assert a reset condition. As long as MR is LOW, the reset remains asserted. Reset is released in typically 185 ms (reset delay time) after MR goes HIGH. When unused, the MR pin is connected to V <sub>DD</sub> or left floating.		

### MAX6401/MAX6404

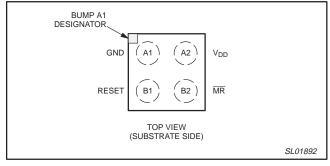


Figure 3. MAX6401/MAX6404 pin configuration.

### MAX6401/MAX6404 Pin description

BUMP	SYMBOL	DESCRIPTION
A1	GND	Device ground.
A2	V <sub>DD</sub>	Positive supply voltage.
B1	RESET	Active-HIGH Reset Output. RESET remains HIGH while $V_{DD}$ is below the reset threshold and remains HIGH for at least 100 ms after $V_{DD}$ rises above the reset threshold.
B2	MR	Active-LOW Manual Reset. Internal 50 k $\Omega$ pull-up resistor to V <sub>DD</sub> . Pull LOW to assert a reset condition. As long as $\overline{MR}$ is LOW, the reset remains asserted. Reset is released in typically 185 ms (reset delay time) after $\overline{MR}$ goes HIGH. When unused, the $\overline{MR}$ pin is connected to V <sub>DD</sub> or left floating.

### **MAXIMUM RATINGS**

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V <sub>DD</sub>	Supply voltage		-0.3	+6	V
	Voltage RESET, RESET (push-pull)		-0.3	V <sub>DD</sub> + 0.3	V
	Voltage RESET (open drain)		-0.3	+6	V
	Voltage manual reset, MR		-0.3	V <sub>CC</sub> + 0.3	V
I <sub>IN</sub>	Input current (any pin)		-	20	mA
I <sub>OUT</sub>	Output current (any pin)		-	20	mA
T <sub>amb</sub>	Ambient temperature range		-40	+85	°C
T <sub>stg</sub>	Storage temperature range		-65	+150	°C
PD	Power dissipation, 4-bump WL-CSP	Derate 3.8 mW/°C above $T_{amb}$ = 70 °C	_	303	mW

# MAX6400/MAX6401/MAX6402/ MAX6403/MAX6404/MAX6405

### **ELECTRICAL CHARACTERISTICS**

 $V_{DD}$  = full range ( $T_{amb}$  = -40 °C to +85 °C) unless otherwise specified. Typical values are at  $T_{amb}$  = +25 °C and  $V_{DD}$  = 3 V (Note 1).

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V <sub>DD</sub>	Supply voltage range	$T_{amb} = 0 \ ^{\circ}C \ to +70 \ ^{\circ}C$	1.0	-	5.5	V
		$T_{amb} = -40 \text{ °C to } +85 \text{ °C}$	1.2	-	5.5	V
I <sub>DD</sub>	Supply current	$\label{eq:VDD} \begin{array}{l} V_{DD} = 3.0 \text{ V for } V_{th} \leq 2.93 \text{ V}; \\ V_{DD} = 3.2 \text{ V for } V_{th} \geq 2.93 \text{ V, no load} \end{array}$	-	0.5	1.0	μA
		V <sub>DD</sub> = 5.5 V, no load	-	1.0	1.75	μΑ
V <sub>th</sub>	Reset threshold (see Table 1)	T <sub>amb</sub> = +25 °C	V <sub>th</sub> - 1.5%	V <sub>th</sub>	V <sub>th</sub> + 1.5%	V
		$T_{amb} = -40 \ ^{\circ}C \ to \ +85 \ ^{\circ}C$	$V_{th} - 2.5\%$	V <sub>th</sub>	V <sub>th</sub> + 2.5%	V
∆V <sub>th</sub> /°C	Reset threshold temperature coefficient		-	40	-	ppm/°
V <sub>hys</sub>	Reset threshold hysteresis	MAX6400/MAX6401/MAX6402	-	6.3	-	mV
		MAX6403/MAX6404/MAX6405	-	9.5	-	mV
t <sub>RD</sub>	V <sub>DD</sub> to Reset release delay	$V_{DD} = (V_{th} + 100 \text{ mV}) \text{ to } (V_{th} - 100 \text{ mV})$	-	20	-	μs
t <sub>RP</sub>	Reset active time-out period		100	185	280	ms
V <sub>IL</sub>	LOW-level input voltage on MR pin	V <sub>th</sub> > 4.0 V	-	-	0.8	V
		$V_{th} \le 4.0 \text{ V}$	-	-	$0.2 \times V_{DD}$	V
V <sub>IH</sub>	HIGH-level input voltage on MR pin	V <sub>th</sub> > 4.0 V	2.0	-	-	V
		$V_{th} \le 4.0 \text{ V}$	$0.7 \times V_{DD}$	-	-	V
t <sub>MD</sub>	MR minimum input pulse width		1	-	-	μs
	MR glitch rejection		-	100	-	ns
t <sub>MR</sub>	MR to Reset time delay		-	200	-	ns
	MR pull-up resistance		25	50	75	kΩ
V <sub>OL</sub> (RESET)	LOW-level output voltage on RESET pin	I <sub>SINK</sub> = 1.6 mA; V <sub>DD</sub> > 2.1 V; RESET asserted	-	-	0.3	V
	(MAX6400/MAX6402/ MAX6403/MAX6405)	I <sub>SINK</sub> = 100 μA; V <sub>DD</sub> > 2.1 V; RESET asserted	-	_	0.4	V
V <sub>OH</sub> (RESET)	HIGH-level output voltage on RESET pin	$I_{SOURCE}$ = 500 $\mu$ A; $V_{DD}$ = 3.2 V; MAX6400 only; RESET released	$0.8 \times V_{DD}$	-	-	V
	(MAX6400/MAX6403)	$\begin{array}{l} I_{SOURCE} = 800 \; \mu \text{A}; \; \text{V}_{\text{DD}} = 4.5 \; \text{V}; \\ \text{V}_{th} \leq 4.38 \; \text{V}; \; \overline{\text{RESET}} \; \text{released} \end{array}$	$0.8 \times V_{DD}$	-	-	V
		$\label{eq:source} \begin{array}{l} I_{SOURCE} = 800 \; \mu\text{A}; \; V_{DD} = V_{th(max)}; \\ V_{th} \geq 4.5 \; V; \; \overline{\text{RESET}} \; \text{released} \end{array}$	$0.8 \times V_{DD}$	-	-	V
V <sub>OH(RESET)</sub>	HIGH-level output voltage on RESET pin	$I_{SOURCE}$ = 500 µA; $V_{DD} \ge 2.1$ V; RESET asserted	$0.8 \times V_{DD}$	-	-	V
	(MAX6401/MAX6404)	$I_{SOURCE}$ = 50 µA; $V_{DD} \ge$ 1.2 V; RESET asserted	$0.8 \times V_{DD}$	-	-	V
V <sub>OL(RESET)</sub>	LOW-level output voltage on RESET pin	$I_{SINK}$ = 1.2 mA, $V_{DD} \ge$ 3.2 V; RESET released; MAX6401 only	-	_	0.3	V
	(MAX6401/MAX6404)	$\label{eq:ISINK} \begin{array}{l} I_{SINK} = 3.2 \text{ mA}, \ V_{DD} \geq 4.5 \ V; \\ V_{th} \leq 4.38 \ V; \ RESET \ released \end{array}$	-	-	0.4	V
		$I_{SINK}$ = 3.2 mA, $V_{DD}$ = $V_{th(max)}$ ; Vth ≥ 4.5 V; RESET released	-	_	0.4	V
	Open drain RESET output leakage current (Note 2)	RESET released	-	-	0.1	μΑ

NOTES:

1. Over-temperature limits are guaranteed by design and are not production tested.

2. Guaranteed by design; not production tested.

# MAX6400/MAX6401/MAX6402/ MAX6403/MAX6404/MAX6405

#### TIMING DIAGRAM

The timing diagram in Figure 4 depicts the operation of the device. Letters indicate events on the TIME axis.

On power-up, when  $V_{\text{DD}}$  reaches 1 V,  $\overline{\text{RESET}}$  is guaranteed to be a logic LOW.

At Event A, V<sub>DD</sub> rises to reset threshold voltage, V<sub>th</sub>. At this time, the internal reset delay timer is initiated. RESET and remains asserted for a reset delay time, t<sub>RP</sub> of typically 180 ms after the supply voltage rises above the reset threshold, V<sub>th</sub>.

Event B: At this time, the reset is released. RESET goes HIGH. The reset delay time helps to ensure valid reset signals with erratic changes in supply voltage.

Events C–E: At Event C, under brown-out conditions, V<sub>DD</sub> falls below the reset threshold minus the hysteresis voltage, V<sub>hys</sub>, the reset signal is asserted. When power recovers and V<sub>DD</sub> rises above the reset threshold, it once again initiates the reset delay timer

(Event D). At Event E,  $V_{DD}$  falls below the reset threshold before the reset delay time is reached, and reset remains asserted.

At F, the  $V_{DD}$  rises above the reset threshold and remains above the reset threshold for typically 185 ms. At G, the reset is once again released.

At H, the  $\overline{MR}$  is externally pulled LOW for greater than 1 µs (minimum  $\overline{MR}$  pulse width, t<sub>MD</sub> for V<sub>DD</sub> = +5 V).

At I, the manual reset is asserted in 200 ns (typical  $\overline{MR}$  to reset out delay time,  $t_{MR}$  for V\_{CC} = +5 V).

At J, the  $\overline{\text{MR}}$  pin returns HIGH. At this point, reset delay timer is initiated and in typically 180 ms (at K), the reset condition is released.

Event L: On power-down, when  $V_{DD}$  falls below  $V_{th} - V_{hys}$ , RESET is guaranteed to be asserted until  $V_{DD}$  falls below 1 V.

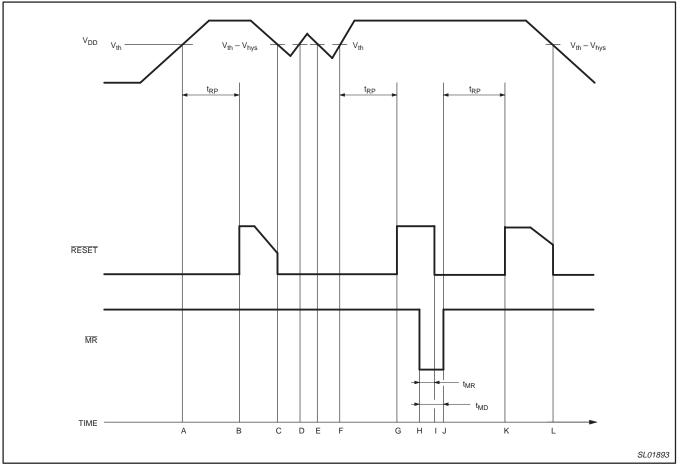


Figure 4. Timing diagram.

# MAX6400/MAX6401/MAX6402/ MAX6403/MAX6404/MAX6405

## **TECHNICAL DISCUSSION**

### **General discussion**

MAX6400–MAX6405 microprocessor ( $\mu$ P) supervisory ICs provide system protection by monitoring power supply voltage and asserting a reset signal if the supply falls below the specified threshold. The MAX6402/MAX6405 have an active-LOW open drain output. The MAX6400/MAX6403 have an active-LOW, push-pull output; while the MAX6401/MAX6404 have an active-HIGH, push-pull output. The reset state is guaranteed to remain valid as long as V<sub>DD</sub> is above +1 V.

### **Threshold levels**

The reset threshold voltages are factory trimmable from 2.2 V to 4.63 V in approximately 100 mV increments. Sample stock is available for all standard threshold voltages shown in Table 1, "Factory-trimmed reset thresholds". Guaranteed threshold voltage tolerance is  $\pm 1.5\%$  at T<sub>amb</sub> = 25 °C and  $\pm 2.5\%$  over the operating ambient temperature, T<sub>amb</sub> = -40 °C to +85 °C.

### **Manual Reset**

The manual reset input,  $\overline{\text{MR}}$  is active-LOW logic. It allows the RESET to be asserted by a pushbutton switch. A mechanical pushbutton switch is effectively debounced by the glitch filter. The typical glitch rejection is 100 ns.  $\overline{\text{MR}}$  may be driven from an external logic circuit since it is TTL/CMOS compatible. The minimum  $\overline{\text{MR}}$  input pulse is 1 µs for V<sub>DD</sub> = +1.2 V to +5.5 V. When not in use, the pin is left floating or tied to V<sub>DD</sub>.

# MAX6400/MAX6401/MAX6402/ MAX6403/MAX6404/MAX6405

### **APPLICATION INFORMATION**

### Interfacing to $\mu$ Ps with bi-directional reset pins

The MAX6402/MAX6405 RESET outputs are open drain and are easily interfaced with microprocessors which have bi-directional reset pins, such as the Motorola 68HC11. Directly connecting the MAX6402/MAX6405 RESET output to the  $\mu$ P's reset input and providing a pull-up resistor to V<sub>DD</sub> allows either device to independently assert reset (Figure 5).

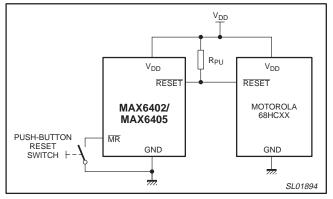


Figure 5. Interfacing to  $\mu$ Ps with bi-directional reset pins.

### Negative-going V<sub>DD</sub> transients

The MAX6400–MAX6405 Series resets are relatively immune to short duration, negative-going  $V_{DD}$  transients or power glitches. This capability greatly reduces false resets with short -duration pulses.

Figure 6, "Maximum transient duration versus reset comparator overdrive" shows the maximum transient condition for which reset signals are not generated. The graph shows the maximum pulse width that a negative-going transient may have before it will generate a reset signal. **Note:** as the amplitude of the transient increases, the maximum allowable transient pulse width decreases.

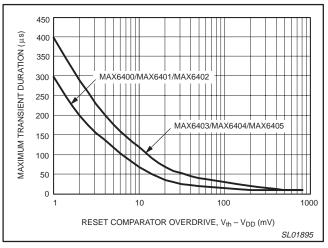
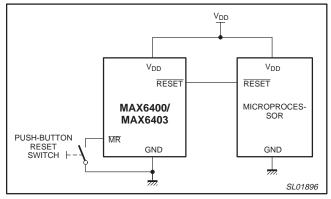


Figure 6. Maximum transient duration versus reset comparator overdrive.

#### System configurations with various $\mu$ Ps

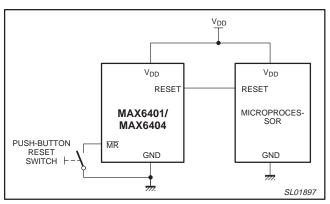
The MAX6400–MAX6405 Series resets provide a system solution for various  $\mu$ Ps. Figures 7 and 8, respectively, reference the Philips  $\mu$ Ps which are compatible with the MAX6400/MAX6403 and MAX6401/MAX6404 system resets.



#### NOTE:

 Philips microprocessors with active-LOW resets: All 16-bit devices from the XA family (XA-Cxx, XA-Gxx, XA-Sxx, XA-Hxx), all LPC7xx devices (P87LPC760/761/762/767/768/769, P80C591/P87C591 (with on-chip CAN controller).

# Figure 7. μP system diagram using MAX6400/MAX6403 push-pull, active-LOW resets.



#### NOTE:

1. Philips microprocessors with active-HIGH resets: 8xC5x, 8xC3x, 8xC5xX2, 8xC3xX2, 8xC51Fx, 8xC51Rx+, 89C51Rx2, 89C66x, 8xC554, 8xC552, etc.

# Figure 8. $\mu P$ system diagram using MAX6401/MAX6404 push-pull, active-HIGH resets.

# MAX6400/MAX6401/MAX6402/ MAX6403/MAX6404/MAX6405

### **PACKING METHOD**

The MAX6401–MAX6405 Series are packed in reels, as shown in Figure 9.

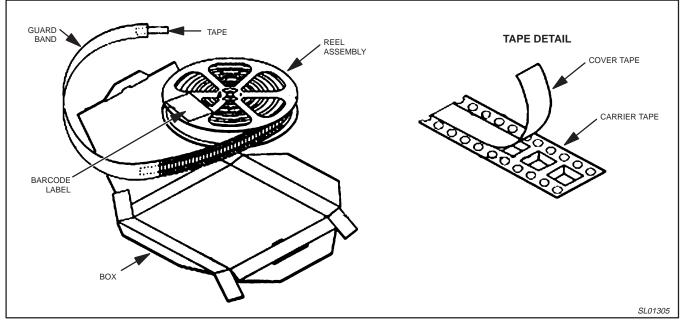
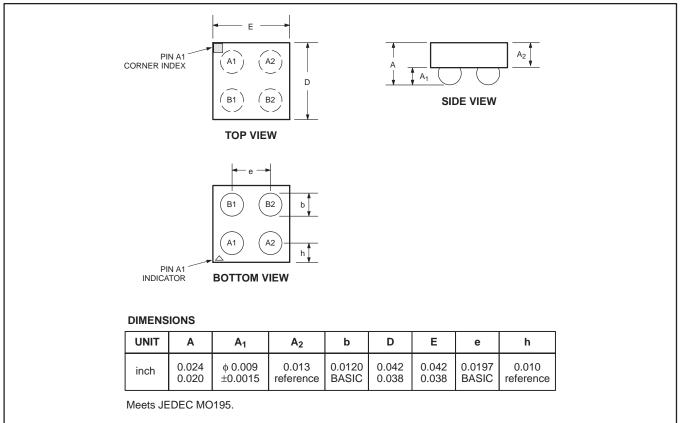


Figure 9. Tape and reel packing method.





# MAX6400/MAX6401/MAX6402/ MAX6403/MAX6404/MAX6405

### **REVISION HISTORY**

Rev	Date	Description
_1	20030527	Product data (9397 750 10644); ECN 853-2428 29962 of 27 May 2003

### Data sheet status

Level	Data sheet status <sup>[1]</sup>	Product status <sup>[2] [3]</sup>	Definitions
I	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

#### Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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### **Contact information**

For additional information please visit http://www.semiconductors.philips.com. Fax:

sales.addresses@www.semiconductors.philips.com

For sales offices addresses send e-mail to:

Fax: +31 40 27 24825

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Date of release: 05-03

9397 750 10644

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